

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT				
NATURE OF CONVEYANCE:	Corrective Assignment to correct the assignee name to read Hynix Semiconductor Inc. previously recorded on Reel 014079 Frame 0089. Assignor (s) hereby confirms the assignment.				
CONVEYING PARTY DATA					
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Seong-Cheol Byun</td><td>11/13/2002</td></tr></tbody></table>	Name	Execution Date	Seong-Cheol Byun	11/13/2002	
Name	Execution Date				
Seong-Cheol Byun	11/13/2002				
RECEIVING PARTY DATA					
Name:	Hynix Semiconductor Inc.				
Street Address:	San 136-1, Ami-ri				
Internal Address:	Bubal-eup Icheon-Shi				
City:	Gyeonggi-do				
State/Country:	REPUBLIC OF KOREA				
PROPERTY NUMBERS Total: 1					
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Patent Number:</td><td>6670205</td></tr></tbody></table>	Property Type	Number	Patent Number:	6670205	
Property Type	Number				
Patent Number:	6670205				
CORRESPONDENCE DATA					
Fax Number:	(312)474-0448				
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>					
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ATTORNEY DOCKET NUMBER:	FIRM CHARGE				
NAME OF SUBMITTER:	Karen Morfoot				
Total Attachments: 4 source=hynix#page1.tif source=hynix#page2.tif					

OP \$40.00 6670205

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PATENT
REEL: 022299 FRAME: 0661

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05-21-2003

Form PTO-1595
(Rev. 03/01)
OMB No. 0651-0027 (exp. 5/31/2002)



102452849

U.S. DEPARTMENT OF COMMERCE
U.S. Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof

1. Name of conveying party(ies):

Seong-Cheol Byun

S-14.03

Additional name(s) of conveying party(ies)
attached? ☐ Yes ☒ No

3. Nature of Conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Execution Date: November 13, 2002

2. Name and address of receiving party(ies)

Name: Hynix Semiconductor Inc.

Internal Address:

Street Address:

San 136-1, Ami-ri
Bubal-eup
Icheon-shi

City: Gyeonggi-do

Country Republic of Korea

Zip:

Additional name(s) &
address(es) attached: ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the new application is:

A. Patent Application No.: 10/365,987

B. Patent No.(s):

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Michael R. Hull

Internal Address: Atty. Dkt.: 29925/39053

Street Address: 6300 Sears Tower
233 S. Wacker Drive

City:
Chicago

State: IL Zip:
60606-6357

6. Total number of applications and patents involved:

7. Total fee (37 CFR 3.41)

\$ 40.00

☒ Enclosed☐ Authorized to be charged to deposit account

8. Deposit account number:

13-2855

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Michael R. Hull
Reg. No. 35,902

Name of Person Signing

Signature

May 14, 2003

Date

Total number of pages including cover sheet, attachments, and documents: 3

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PATENT
REEL: 022299 FRAME: 0663

ASSIGNMENT

Serial No: 10/365,987Filed: February 13, 2003Title: Method of Fabricating Image Sensor Equipped with Lens

For ten dollars (\$10.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assign to, Hynix Semiconductor Inc. of San 136-1, Ami-ri, Bubal-eup, Icheon-shi, Gyeonggi-do, Republic of Korea (hereinafter "assignee"), its successors and assigns, the entire right, title and interest in the invention or improvements of the undersigned disclosed in the above-identified application for Letters Patent of the United States, and in said application and any and all other applications, both United States and foreign, which the undersigned may file, either solely or jointly with others, on said invention or improvements, and in any and all Letters Patent of the United States and foreign countries, which may be obtained on any of said applications, and in any reissue or extension thereof.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue said Letters Patent to said assignee.

The undersigned hereby authorize(s) and request(s) the attorneys of record in said application to insert in this assignment the executed date and/or filing date and serial number of said application when officially known.

The undersigned warrant(s) themselves (himself/herself) to be the owners (owner) of the interest herein assigned and to have the right to make this assignment and further warrant that there are no outstanding prior assignments, licenses, or other rights in the interest herein assigned.

For said consideration the undersigned hereby agree(s), upon the request and at the expense of said assignee, its successors and assigns, to execute any and all divisional, continuation, continuation-in-part and substitute applications for said invention or improvements, and any necessary oath or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon said application, and any and all applications and other documents for Letters Patent in foreign countries on said invention or improvements, that said assignee, its successors or assigns, may deem necessary or expedient, and for said consideration the undersigned further agree(s) upon the request of said assignee, its successors or assigns, in the event of any application or Letters Patent assigned herein becoming involved in Interference, to cooperate to the best of the ability of the undersigned with said assignee, its successors or assigns, in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof, the undersigned hereby agreeing to perform, upon request, any and all affirmative acts to obtain said Letters Patent, both United States and foreign, and vest all rights therein hereby conveyed in said assignee, its successors and assigns, whereby said Letters Patent will be held and enjoyed by said assignee, its successors and assigns, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

Foreign

WITNESS my (our) hand(s) this ____13th____ day of ____November____, 2002.

Witnesses:

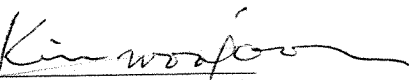
1)


Name: KIM, Hae-in



BYUN, Seong-cheol

2)


Name: KIM, Woo-joon
